# FAIRCHILD

SEMICONDUCTOR TM

# **FDS9431A** P-Channel 2.5V Specified MOSFET

# **General Description**

This P-Channel 2.5V specified MOSFET is produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process has been especially tailored to minimize on-state resistance and yet maintain superior switching performance.

# Applications

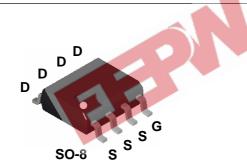
- DC/DC converter
- Power management
- Load switch
- Battery protection

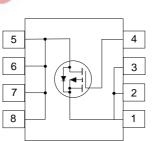
# September 1999

# FDS9431A

### Features

- -3.5 A, -20 V.  $R_{DS(ON)} = 0.130 \ \Omega \ @ V_{GS} = -4.5 \ V$  $R_{DS(ON)} = 0.180 \ \Omega \ @ V_{GS} = -2.5 \ V.$
- Fast switching speed.
- High density cell design for extremely low R<sub>DS(ON)</sub>.
- High power and current handling capability.





# Absolute Maximum Ratings TA=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V <sub>DSS</sub>	Drain-Source Voltage		-20	V
V <sub>GSS</sub>	Gate-Source Voltage		±8	V
ID	Drain Current - Continuous	(Note 1a)	-3.5	A
	- Pulsed		-18	
PD	Power Dissipation for Single Operation	(Note 1a)	2.5	W
		(Note 1b)	1.2	
		(Note 1c)	1.0	
TJ, T <sub>stg</sub>	Operating and Storage Junction Temperat	ture Range	-55 to +150	°C

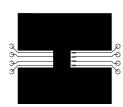
# **Thermal Characteristics**

R <sub>0JA</sub>	Thermal Resistance, Junction-to-Ambient	(Note 1a)	50	°C/W
R <sub>θJC</sub>	Thermal Resistance, Junction-to-Case	(Note 1)	25	°C/W

# Package Marking and Ordering Information

-	Device Marking	Device Marking Device		Tape width	Quantity	
'	FDS9431A	FDS9431A	13"	12mm	2500 units	

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
Off Cha	acteristics			ļ	ļ	ļ
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0 V, I <sub>D</sub> = -250 μA	-20			V
<u>ΔBVdss</u> ΔTJ	Breakdown Voltage Temperature Coefficient	$I_D$ = -250 µA,Referenced to 25°C		-28		mV/°(
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = -16 V, V_{GS} = 0 V$			-1	μA
IGSSF	Gate-Body Leakage Current, Forward	$V_{GS} = 8 \text{ V},  V_{DS} = 0 \text{ V}$			100	nA
GSSR	Gate-Body Leakage Current, Reverse	$V_{GS} = -8 \text{ V},  V_{DS} = 0 \text{ V}$			-100	nA
On Char	acteristics (Note 2)					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	-0.4	-0.6	-1	V
<u>ΔVgs(th)</u> ΔTJ	Gate Threshold Voltage Temperature Coefficient	$I_D$ = -250 µA,Referenced to 25°C		2		mV/°(
R <sub>DS(on)</sub>	Static Drain-Source	$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -3.5 \text{ A}$		0.110	0.130	Ω
	On-Resistance	$V_{GS} = -2.5 \text{ V}, I_D = -3.0 \text{ A}$ $V_{GS} = -4.5 \text{ V}, I_D = -3.5 \text{ A}$	a	0.140 0.155	0.180	Ω
		T <sub>J</sub> =125°C	1	0.155	0.220	Ω
I <sub>D(on)</sub>	On-State Drain Current	V <sub>GS</sub> = -4.5 V, V <sub>DS</sub> =-5 V	-10			Α
<b>g</b> fs	Forward Transconductance	V <sub>DS</sub> = -5 V, I <sub>D</sub> = -3.5 A		6.5		S
Dynamic	Characteristics					
Ciss	Input Capacitance	$V_{DS} = -10 V, V_{GS} = 0 V,$		405		pF
Coss	Output Capacitance	f = 1.0 MHz		170		pF
Crss	Reverse Transfer Capacitance			45		pF
Switchir	g Characteristics (Note 2)					
t <sub>d(on)</sub>	Turn-On Delay Time	$V_{DD} = -5 V, I_D = -1 A,$		6.5	13	ns
tr	Turn-On Rise Time	$V_{\rm GS} = -4.5  \text{V},  \text{R}_{\rm GEN} = 6  \Omega$		20	35	ns
t <sub>d(off)</sub>	Turn-Off Delay Time			31	50	ns
t <sub>f</sub>	Turn-Off Fall Time	-		21	35	ns
Qg	Total Gate Charge	V <sub>DS</sub> = -5 V, I <sub>D</sub> = -3.5 A,		6	8.5	nC
Q <sub>gs</sub>	Gate-Source Charge	V <sub>GS</sub> = -4.5 V		0.8		nC
Q <sub>gd</sub>	Gate-Drain Charge	1		1.3		nC
Drain-94	Durce Diode Characteristics	and Maximum Patings	ļ	ļ	ļ	ļ
ls	Maximum Continuous Drain-Source				-2.1	A
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	$V_{GS} = 0 V, I_S = -2.1 A$ (Note 2)		-0.7	-1.2	V

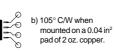


Scale 1:1 on letter size paper

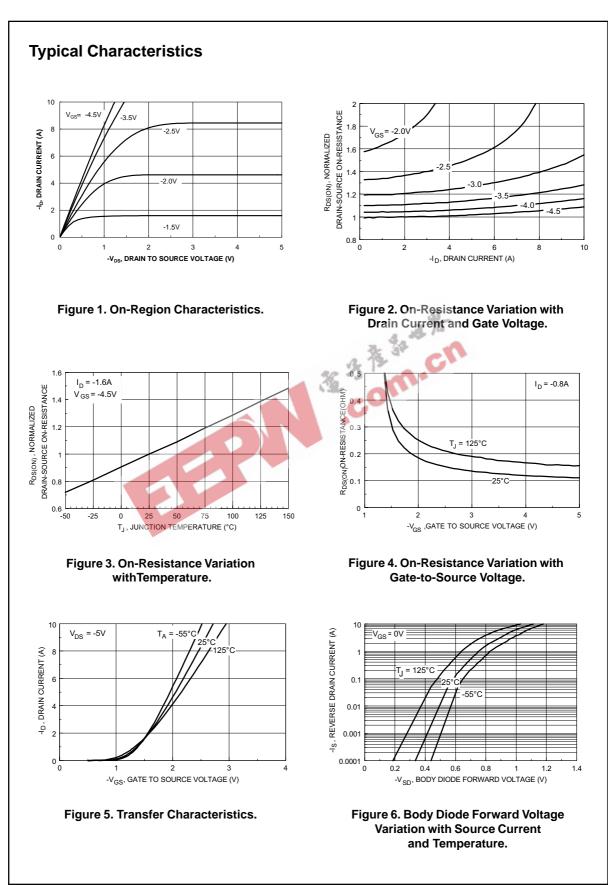
2: Pulse Test: Pulse Width  $\leq$  300  $\mu s,$  Duty Cycle  $\leq$  2.0%



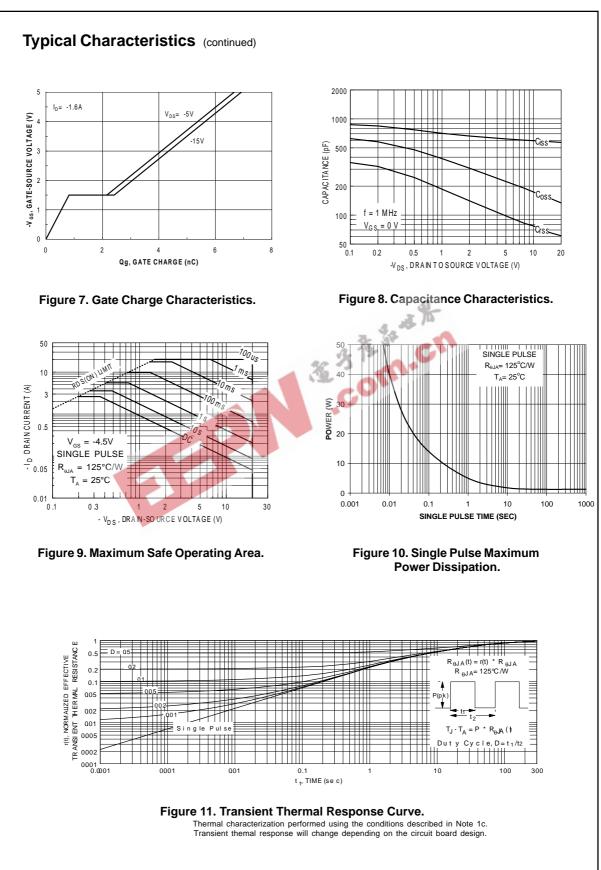




c) 125° C/W on a minimum mounting pad. FDS9431A

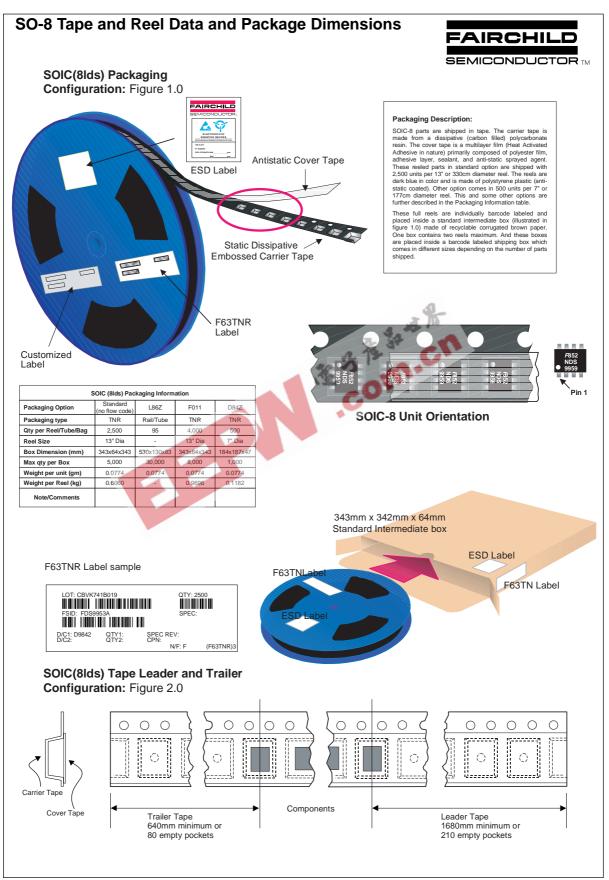


# FDS9431A

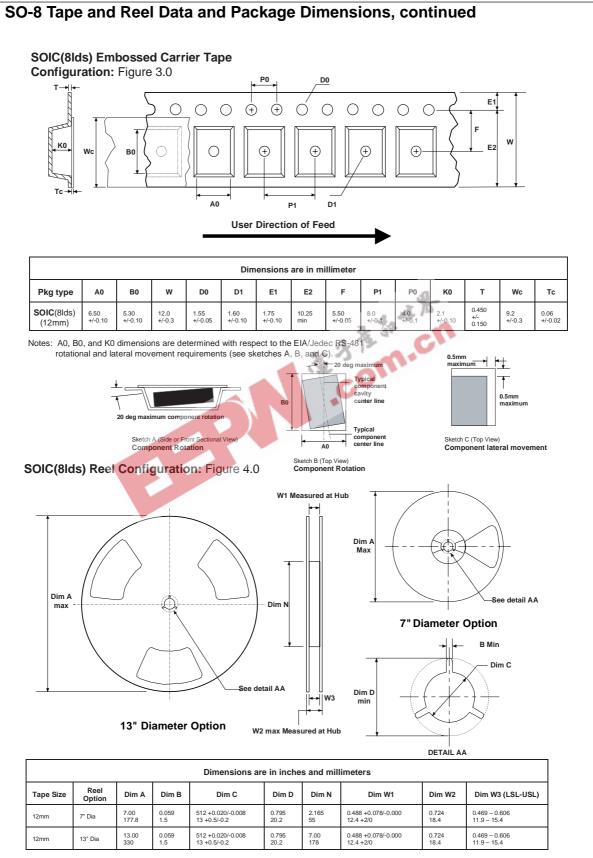


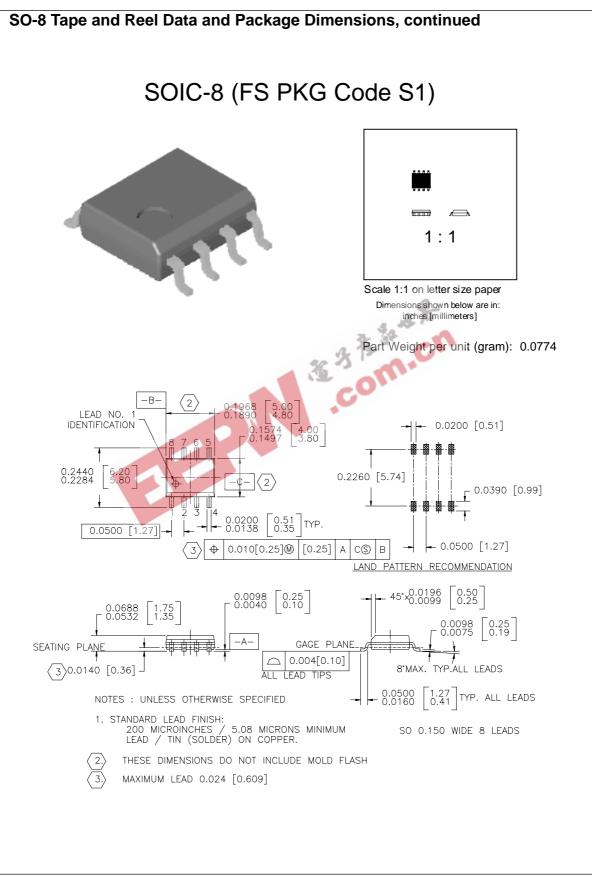
# FDS9431A

FDS9431A Rev. A2



July 1999, Rev. B





# TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

ACEx™	ISOPLANAR™	UHC™
CoolFET™	MICROWIRE™	VCX™
CROSSVOLT™	POP™	
E²CMOS™	PowerTrench™	
FACT™	QS™	
FACT Quiet Series™	Quiet Series <sup>™</sup>	
FAST®	SuperSOT™-3	
FASTr™	SuperSOT™-6	
GTO™	SuperSOT™-8	
HiSeC™	TinyLogic™	

#### DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

### LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user. 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

### **PRODUCT STATUS DEFINITIONS**

#### **Definition of Terms**

Product Status	Definition
Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.
	Formative or In Design First Production Full Production